

Global Initiative on Academic Network (GIAN), Course Advanced Electron Microscopy for Materials Science Invited Faculty: Prof. Dr. Benjamin Butz, University of Siegen, Germany Duration: 13-22 March 2018 at Jawaharlal Nehru University (JNU)



Objectives

- Providing an overview of state-of-the-art electron microscopy (EM) and its applications in materials science
- Introducing the <u>physical principles of electron(/ion)-sample interaction</u> to understand image formation and spectroscopy in scanning and (scanning) transmission EM (SEM, (S)TEM)
- Explaining the <u>functional principles and practices of alignment</u> of such microscopes for SEM and (S)TEM
- Explaining and comparing important imaging, diffraction and spectroscopic SEM & (S)TEM techniques for materials characterization
- Introducting <u>state-of-the-art</u> *in situ* capabilites
 Explaining <u>simulation and interpretation</u> of SEM and TEM data
 Providing practical insight of <u>TEM sample preparation</u>

Tools at Advanced Instrumentation & Research Facility/JNU





Course Content

Lecture Topics

Overview of SEM, (S)TEM techniques, applications	1
Functional principle and alignment of SEM	1
Electron-sample interaction, interaction volume, back-scattered	2
(BSE)/secondary electron(SE) generation, SEM image formation,	
contrast mechanism (topography/chemistry by SE/BSE imaging,	
STEM, back-scatter diffraction (EBSD)), quantitative interpretation	
Focussed-ion beam (FIB) instrumentation, ion-beam microscopy	2
Functional principle and alignment of TEM	1
Electron diffraction (ED) in TEM (single crystal vs. powder):	3
reciprocal space, Kikuchi/HOLZ lines, selected-area ED (SAED),	
convergent-beam ED (CBED)	
Diffraction-contrast (bright-/dark-field) imaging: crystal orientation,	2
thickness fringes, bend contours, dislocation/stacking-fault imaging	
High-resolution TEM (HRTEM): weak-phase object, exit-wave function,	3
contrast-transfer function, aberration correction (AC)	
(High-resolution) STEM: ronchigram alignment, Rutherford/thermal	3
diffuse scattering, Z-contrast imaging, aberration correction	
S(TEM) & FIB tomography	2
Energy-dispersive X-ray spectroscopy (EDXS) in SEM and TEM:	2
detectors, quantification methods, atomic-resolution EDXS	
Electron energy-loss spectroscopy (EELS) in TEM: detector,	2
alignment, quantification, atomic-resolution EELS	
Advanced in situ electron microscopy (SEM, TEM):	3
Equipment/capabilities, applications	
Application of advanced EM on graphene, batteries, fuel cells, etc.	1
Total lecture hrs	28
Demo/Tutorial Topics	
Demonstration of SEM techniques: alignments, SE, BSE, EDX, FIB	3
TEM sample preparation using ion milling and ultramicrotomy	2
Demonstration of TEM techniques:	2
alignment, SAED/CBED, BF/DF imaging, HRTEM	
Demonstration of STEM techniques:	1
alignment, Z-contrast imaging, EDXS	
Indexing of diffraction patterns	3
Simulation of TEM images and diffraction patterns, EELS data analysis	4
Total demo/tutorial hrs	15

Research Examples



a) Debye SAED pattern of SiGe nanoparticles¹, b) <001> SAED pattern of single grain of commercial AI foil (inset shows polycrystals), c) CBED pattern of same AI foil

a Sic Sic 2 layer 3 layer





a) Quantitative SEM of few-layer graphene membrane², b) DF-TEM of dislocations in bilayer graphene (dark lines)³, c) AC-HRTEM of monolayer graphene oxide⁴

Who can attend:

- Students at all levels (BTech/MSc/MTech/PhD) or faculty from reputed academic institutions and technical institutions
- Engineers, researchers and executives, from industry, service and



a) Probe-corrected HRSTEM of La-STO-SRO heterostructure (1 La monolayer & 2-1-2 unit cells of SRO on STO wafer) with atomic-resolution b) EDXS and c) EELS mappings



a) Thermally induced layer exchange by *in situ* TEM heating (ALILE)⁵, b) cryo-EM of Li battery materials⁶, c) environmental TEM (ETEM) study of Li corrosion at RT⁷

¹*Nanoscale* 7 (2015) 5186 ²ACS Nano 7 (2013) 4441 ³Nature 505 (2014) 533 ⁴Angew Chem 128 (2016) 16003 ⁵Scripta Mater 66 (2012) 550 ⁶Science 358 (2017) 506 ⁷Nano Lett 17 (2017) 5171

government organizations including R&D laboratories

Registration, Venue & Course Fees:**

• JNU M.Sc. / M.Tech. students: free

- JNU research students (M. Phil & Ph.D): Rs 1000; JNU Faculty : Rs 2000 Other educational institutes
- Research students: Rs 2000; Faculty : Rs 4000
- government institutes: Rs 10000 ; Industry and private institutes: Rs 15000
 Participants from outside India: US\$ 500

Registration: for pre-registration please apply online at http://www.gian.iitkgp.ac.in & http://gianregister.jnu.ac.in

Number of participants: will be shortlisted to 40 + waiting list of ~15 **Venue:** Special Centre for Nanoscience and AIRF, JNU

Accommodation: We will facilitate in finding accommodation in JNU guest houses and hostels upon request, subject to payment rules and availability. ** does not include boarding and lodging charges (birajdar@mail.jnu.ac.in)

Invited Faculty: Prof. Benjamin Butz, Univ. of Siegen, Germany

Materials physicist and expert in advanced EM at the interface of material characterization and development. To clarify structure-property relations, he utilizes state-of-the-art aberration-corrected TEM and FIB/SEM in combination with modern *in situ* capabilities. His work, in particular on graphene, is published in renowned journals like Nature and Nat. Physics.



Host Faculty: Dr. Balaji Birajdar, Asst. Prof. SCNS, JNU

Solid-state physicist and an expert in structure-property correlations of functional materials using advanced EM. His research fields cover novel ferroelectric, superconducting, and semiconducting thin films and bulk materials. He also synthesizes novel functional materials for photocatalytic, photovoltaic and capacitor applications.

